International IOR Rectifier

Automotive Grade
AUIRS21811S
HIGH AND LOW SIDE DRIVER

Features

- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10V to 20V
- Undervoltage lockout for both channels
- 3.3V and 5V input logic compatible
- Matched propagation delay for both channels
- Lower di/dt gate driver for better noise immunity
- Output source/sink current capability of 1.9A/2.3A typical
- Leadfree, RoHS compliant
- Automotive qualified*

Typical Applications

- Piezo injection
- Electric Power Steering
- Fan and compressor
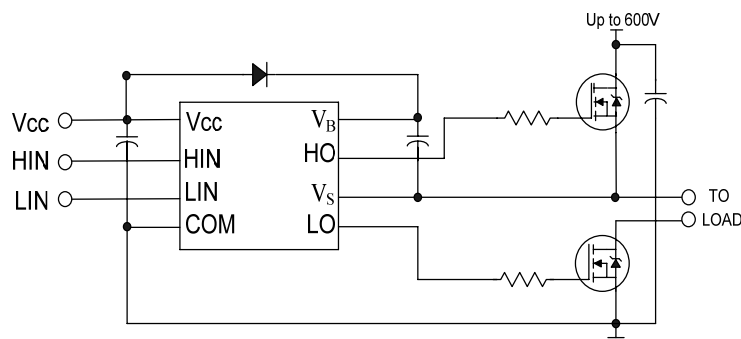- Starter/alternator

Product Summary

Topology	High and Low Side Driver
V_{OFFSET}	≤ 600V
V_{OUT}	10V – 20V
I_{o+} & I_{o-} (typical)	1.9A & 2.3A
t_{on} & t_{off} (typical)	135ns

Package Options

8 - Lead SOIC
AUIRS21811S

Typical Connection Diagram

Up to 600V

Vcc
HIN
LIN

Vcc V_B
HIN   HO
LIN V_S
COM   LO

TO
LOAD

AUIRS21811S

(Refer to Lead Assignments for correct pin configuration). This/These diagram(s) show electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout.

* Qualification standards can be found on IR's web site www.irf.com   © 2009 International Rectifier

AUIRS21811S

International **IΩR** Rectifier

AUIRS21811S

Description

The AUIRS21811S is a high voltage, high speed power MOSFET and IGBT driver with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600V.

Feature Comparison: AUIRS21811/AUIRS2181/AUIRS2183/AUIRS2184

Part	Input Logic	Cross-Conduction Prevention logic	Dead-Time	Ground Pins	Ton/Toff (typical)
21811	HIN/LIN	No	none	COM	135/135 ns
2181	HIN/LIN	No	none	COM	160/200 ns
21814				V$_{SS}$/COM	
2183	$\overline{\text{HIN/LIN}}$	Yes	Internal 500ns	COM	180/220 ns
21834			Programmable 0.4 – 5 us	V$_{SS}$/COM	
2184	$\overline{\text{IN/SD}}$	Yes	Internal 500ns	COM	600/230 ns
21844			Programmable 0.4 – 5 us	V$_{SS}$/COM	

Qualification Information†

Qualification Level		Automotive (per AEC-Q100††)
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.
Moisture Sensitivity Level		MSL3††† 260°C (per IPC/JEDEC J-STD-020)
ESD	Machine Model	Class M3 (Pass +/-250V) (per AEC-Q100-003)
	Human Body Model	Class H2 (Pass +/-2500V) (per AEC-Q100-002)
	Charged Device Model	Class C5 (Pass +/-1250V) (per AEC-Q100-011)
RoHS Compliant		Yes

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/

†† Exceptions to AEC-Q100 requirements are noted in the qualification report.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM lead. Stresses beyond those listed under " Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

Symbol	Definition	Min	Max	Units
V_B	High side floating absolute voltage	-0.3	620	
V_S	High side floating supply offset voltage	V_B - 25	V_B + 0.3	
V_{HO}	High side floating output voltage	V_S - 0.3	V_B + 0.3	V
V_{CC}	Low side and logic fixed supply voltage	-0.3	20	
V_{LO}	Low side output voltage	-0.3	V_{CC} + 0.3	
V_{IN}	Logic input voltage (HIN & LIN)	COM - 0.3	V_{CC} + 0.3	
dV_S/dt	Allowable offset supply voltage transient	—	50	V/ns
P_D	Package power dissipation @ TA ≤ 25°C	—	0.625	W
Rth_{JA}	Thermal resistance, junction to ambient	—	200	°C/W
T_J	Junction temperature	—	150	
T_S	Storage temperature	-50	150	°C
T_L	Lead temperature (soldering, 10 seconds)	—	300	

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. V_S and offset rating are tested with all supplies biased at 15V differential.

Symbol	Definition	Min	Max	Units
V_B	High side floating supply absolute voltage	V_S + 10	V_S + 20	
V_S	High side floating supply offset voltage	†	600	
V_{HO}	High side floating output voltage	V_S	V_B	V
V_{CC}	Low side and logic fixed supply voltage	10	20	
V_{LO}	Low side output voltage	0	V_{CC}	
V_{IN}	Logic input voltage (HIN & LIN)	COM	V_{CC}	
T_A	Ambient temperature	-40	125	°C

† Logic operational for V_S of -5V to +600V. Logic state held for V_S of -5V to $-V_{BS}$. (Please refer to Figure 4 for more details).

Dynamic Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C ≤ Tj ≤ 125°C with bias conditions of $V_{CC} = V_{BS}$ = 15V, V_S = COM, C_L = 1000pF.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
t_{on}	Turn-on propagation delay	—	135	230		V_S = 0V
t_{off}	Turn-off propagation delay	—	135	230		V_S = 0V or 600V
MT	Delay matching, HO & LO turn-on/off	—	—	35	ns	
t_r	Turn-on rise time	—	—	60		V_S = 0V
t_f	Turn-off fall time	—	—	35		V_S = 0V

Static Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C ≤ Tj ≤ 125°C with bias conditions of $V_{CC} = V_{BS}$ = 15V and V_S = COM. The V_{IN} and I_{IN} parameters are referenced to V_{SS}/COM and are applicable to the respective input leads: HIN and LIN. The V_O and I_O parameters are referenced to V_S/COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
V_{IH}	Logic "1" input voltage	2.5	—	—		V_{CC} = 10V to 20V
V_{IL}	Logic "0" input voltage	—	—	0.8	V	
V_{OH}	High level output voltage, $V_{BIAS} - V_O$	—	—	1.4		I_O = 0mA
V_{OL}	Low level output voltage, V_O	—	—	0.2		I_O = 20mA
I_{LK}	Offset supply leakage current	—	—	50		$V_B = V_S$ = 600V
I_{QBS}	Quiescent V_{BS} supply current	25	80	200		V_{IN} = 0V or 5V
I_{QCC}	Quiescent V_{CC} supply current	55	130	260	µA	
I_{IN+}	Logic "1" input bias current	—	25	60		V_{IN} = 5V
I_{IN-}	Logic "0" input bias current	—	—	1.0		V_{IN} = 0V
V_{CCUV+} V_{BSUV+}	V_{CC} and V_{BS} supply undervoltage positive going threshold	8.0	8.9	9.8		
V_{CCUV-} V_{BSUV-}	V_{CC} and V_{BS} supply undervoltage negative going threshold	7.4	8.2	9.0	V	
V_{CCUVH} V_{BSUVH}	V_{CC} and V_{BS} supply undervoltage Hysteresis	0.3	0.7	—		
I_{O25+} [†]	Output high short circuit pulsed current	1.4	1.9	—		V_O = 0V, PW ≤ 10us, T_J = 25°C
I_{O25-} [†]	Output low short circuit pulsed current	1.8	2.3	—	A	V_O = 15V, PW ≤ 10us, T_J = 25°C
I_{O+} [†] [††]	Output high short circuit pulsed current	1.2	—	—		V_O = 0V, PW ≤ 10us
I_{O-} [†] [††]	Output low short circuit pulsed current	1.5	—	—		V_O = 15V, PW ≤ 10us

(†) Guaranteed by design

(††) I_{O+} and I_{O-} decrease with rising temperature

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AUIRS21811S

Functional Block Diagrams

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Input/Output Pin Equivalent Circuit Diagrams

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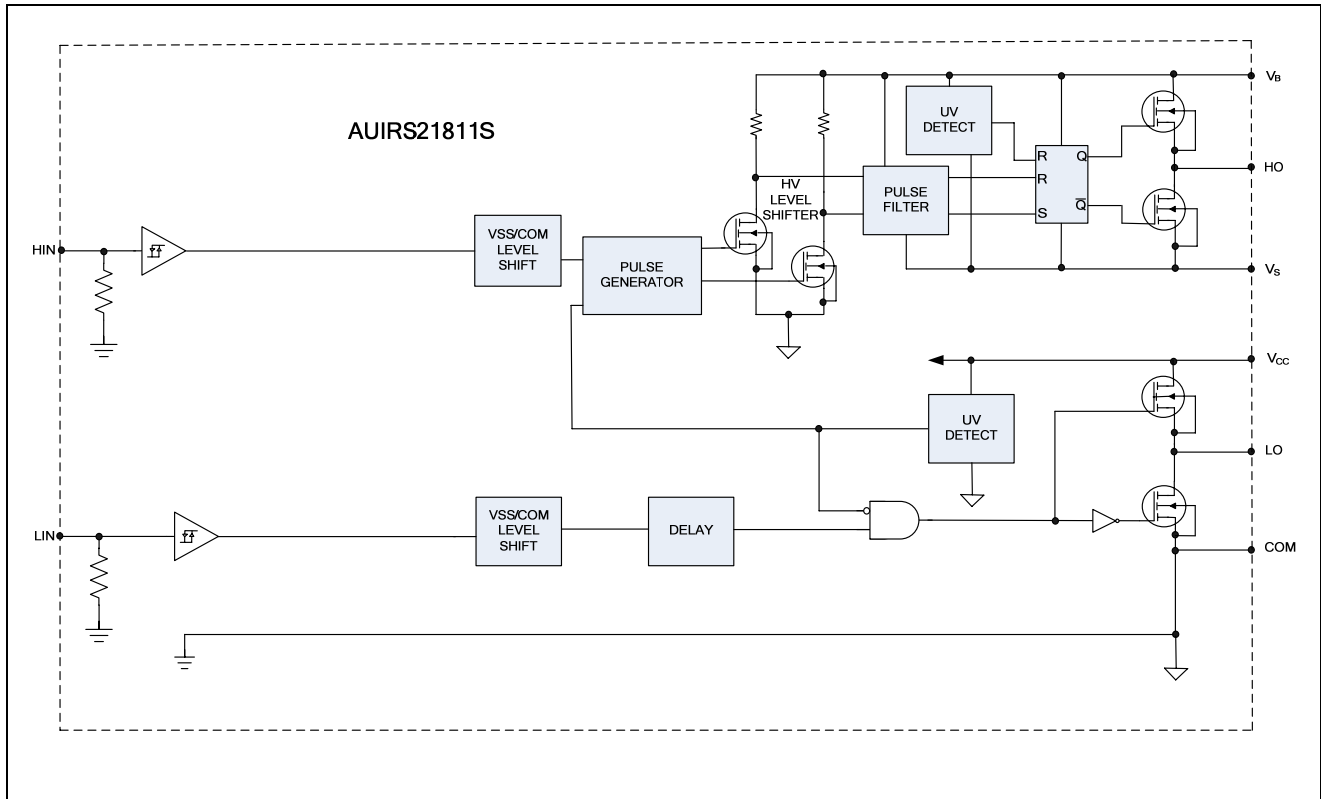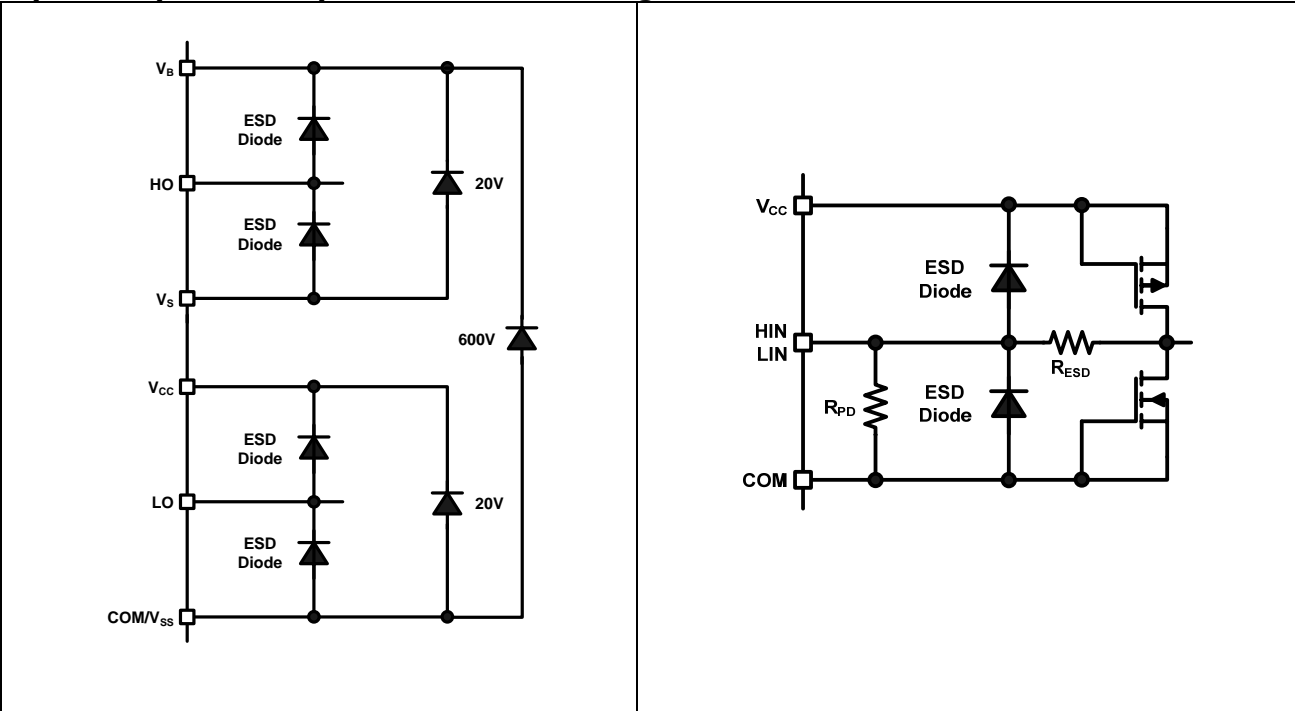
Lead Definitions: AUIRS21811S

Pin#	Symbol	Description
1	HIN	Logic input for high-side driver output (HO), in phase
2	LIN	Logic input for low-side driver output (LO), in phase
3	COM	Low-side return
4	LO	Low-side gate drive output
5	V_{CC}	Low-side and logic fixed supply
6	V_S	High-side floating supply return
7	HO	High-side gate drive output
8	V_B	High-side floating supply

Lead Assignments

```
      ┌─────────────────────────────┐
      │      ┌───────┐              │
 ┌──┐ │     │ HIN  V_B │  ┌──┐      │
 │ 1 │─┤     │          │  │ 8 │     │
 └──┘ │     │          │  └──┘      │
 ┌──┐ │     │ LIN   HO │  ┌──┐      │
 │ 2 │─┤     │          │  │ 7 │     │
 └──┘ │     │          │  └──┘      │
 ┌──┐ │     │ COM   V_S │  ┌──┐     │
 │ 3 │─┤     │          │  │ 6 │     │
 └──┘ │     │          │  └──┘      │
 ┌──┐ │     │ LO   V_CC │  ┌──┐     │
 │ 4 │─┤     │          │  │ 5 │     │
 └──┘ │     └───────┘              │
      │        8 Lead SOIC         │
      └─────────────────────────────┘
```

8 Lead SOIC

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AUIRS21811S
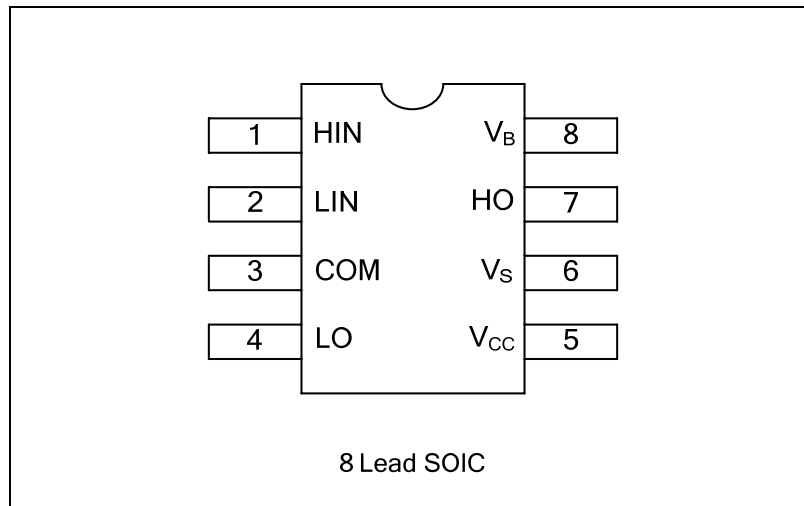
Application Information and Additional Details

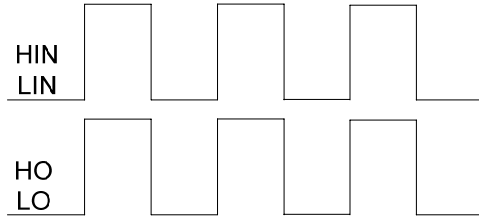**Figure 1. Input/Output Timing Diagram**
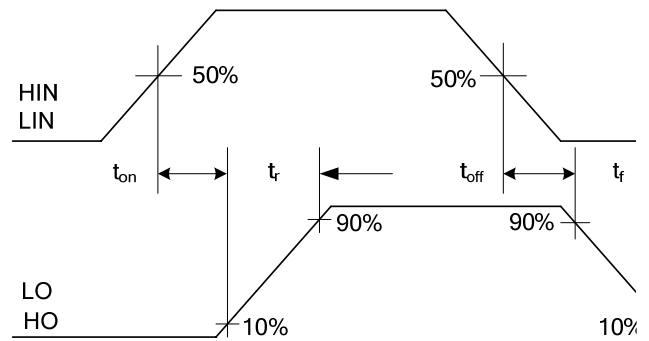
Figure 2. Switching Time Waveform Definitions

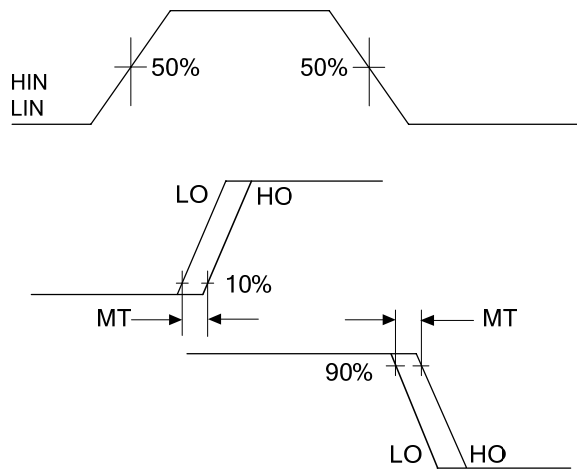**Figure 3. Delay Matching Waveform Definitions**

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Parameter Temperature Trends

Figures 4-16 provide information on the experimental performance of the AUIRS21811S HVIC. The line plotted in each figure is generated from actual lab data. A large number of individual samples were tested at three temperatures (-40 ºC, 25 ºC, and 125 ºC) in order to generate the curves. Each line in the graphs consist of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).
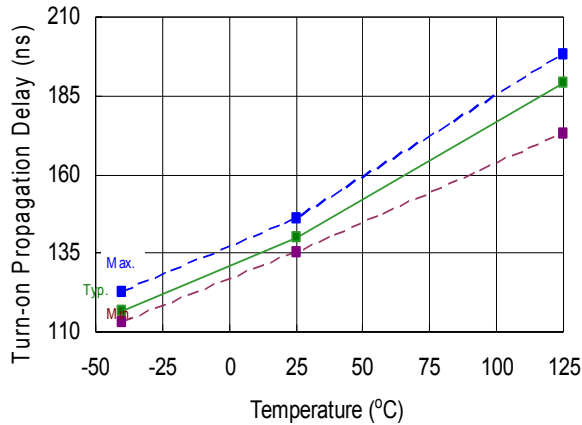
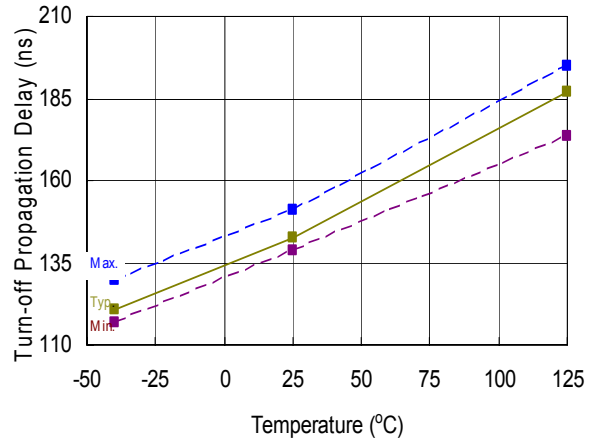**Figure 4. Turn-On Propagation Delay vs. Temperature**

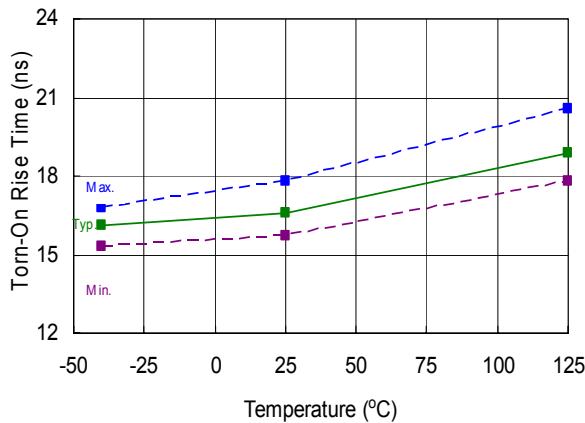**Figure 5. Turn-Off Propagation Delay vs. Temperature**

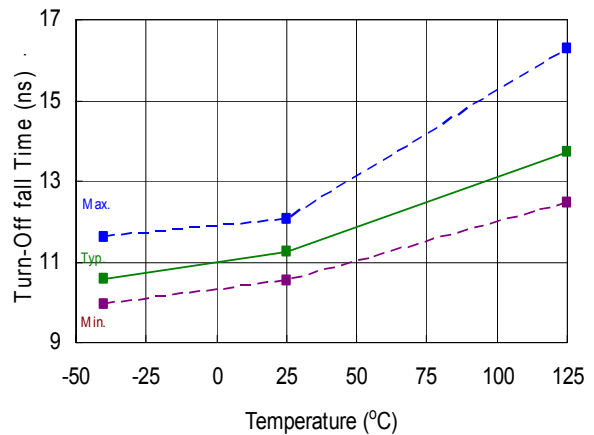**Figure 6. Turn-On Rise Time vs. Temperature**

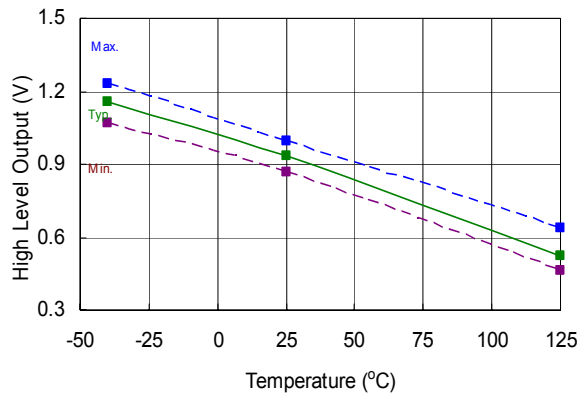**Figure 7. Turn-Off Fall Time vs. Temperature**

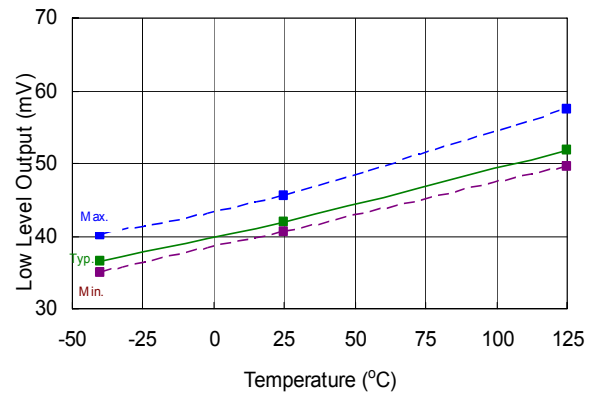**Figure 8. High Level Output Voltage vs. Temperature (Io = 0 mA)**

Figure 9. Low Level Output vs. Temperature
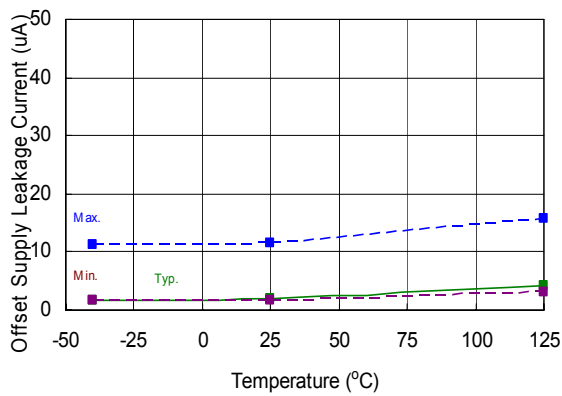
Figure 10. Offset Supply Leakage Current vs. Temperature
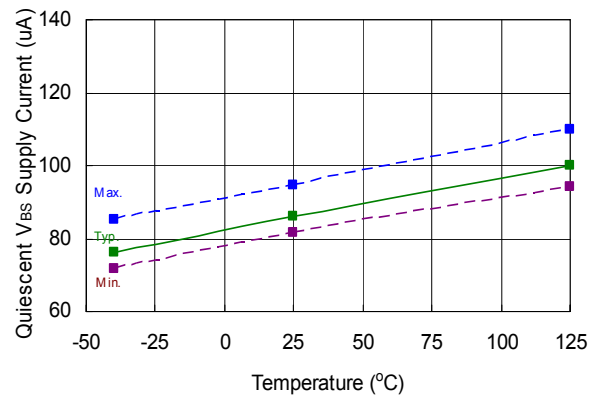
Figure 11. V_{BS} Supply Current vs. Temperature
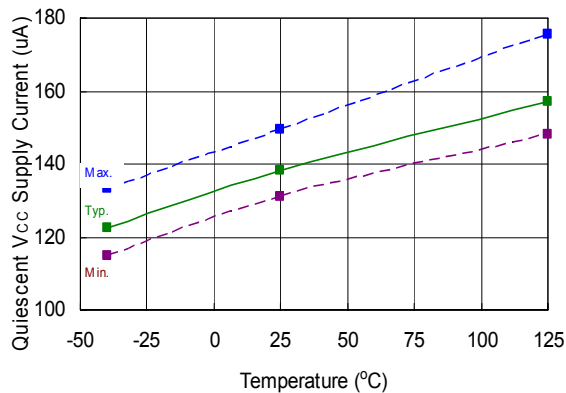
Figure 12. V_{CC} Supply Current vs. Temperature

Figure 13. V_{CC} Undervoltage Threshold (+) vs. Temperature

**Figure 14. V$_{CC}$ Undervoltage Threshold (-)
vs. Temperature**
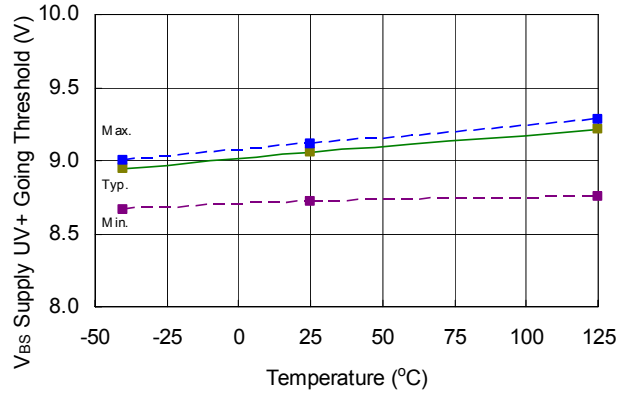
**Figure 15. V$_{BS}$ Undervoltage Threshold (+)
vs. Temperature**
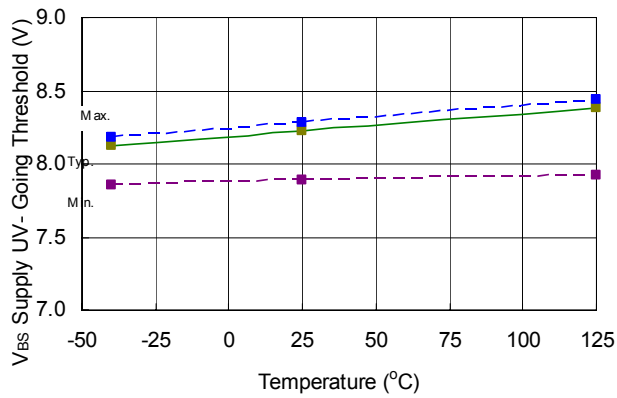
**Figure 16. V$_{BS}$ Undervoltage Threshold (-)
vs. Temperature**

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Package Details: SOIC 8

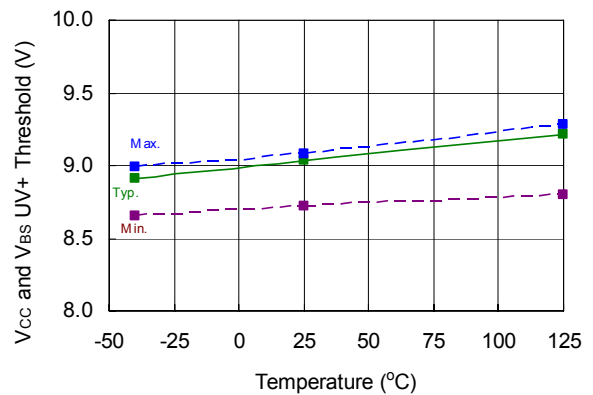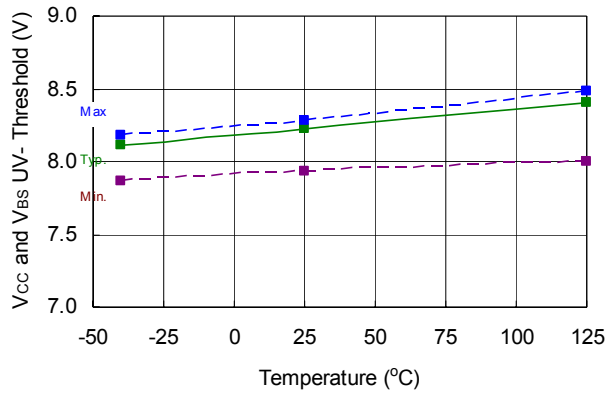| DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e 1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

FOOTPRINT

8X 0.72 [.028]
6.46 [.255]
3X 1.27 [.050]
8X 1.78 [.070]

K x 45°
8X L
8X c

NOTES:
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.

5 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS.
MOLD PROTRUSIONS NOT TO EXCEED 0.15 [.006].
6 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS.
MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.010].
7 DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO
A SUBSTRATE.

01-6027
01-0021 11 (MS-012AA)

8 Lead SOIC

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14

Tape and Reel Details: SOIC8

LOADED TAPE FEED DIRECTION

NOTE : CONTROLLING
DIMENSION IN MM
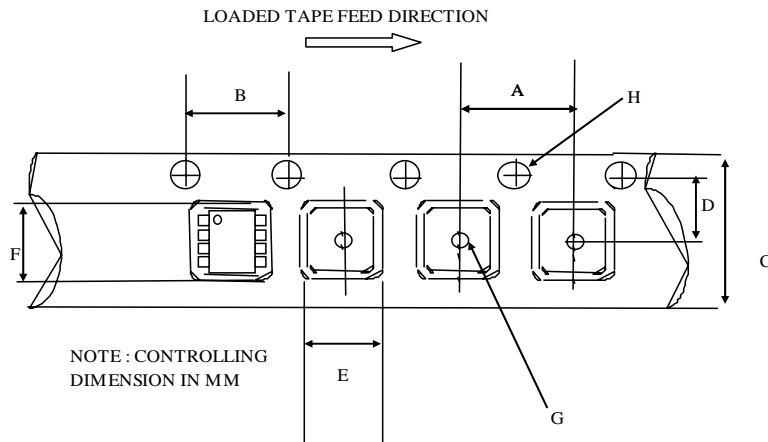
CARRIER TAPE DIMENSION FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062
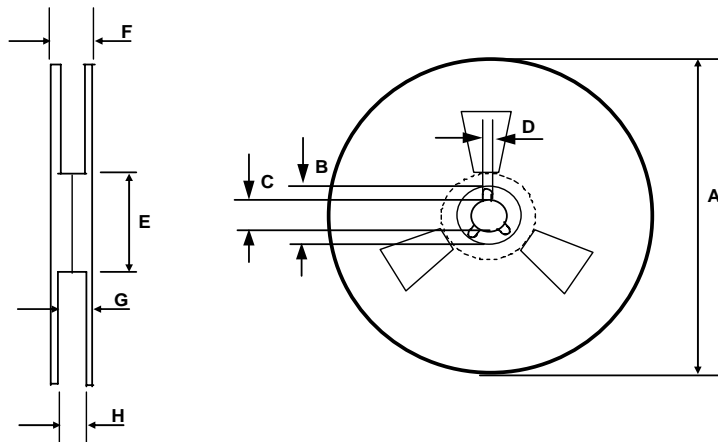
REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

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Part Marking Information

SOIC8:

Part number ——— **AS21811**

Date code ——— **AYWW ?**   **IƆR**   ——— IR logo

Pin 1
Identifier   ●   **? XXXX** ——— Lot Code
(Prod mode –
4 digit SPN code)

Marking Code
(per Marking Spec.)

Assembly site code
Per SCOP 200-002

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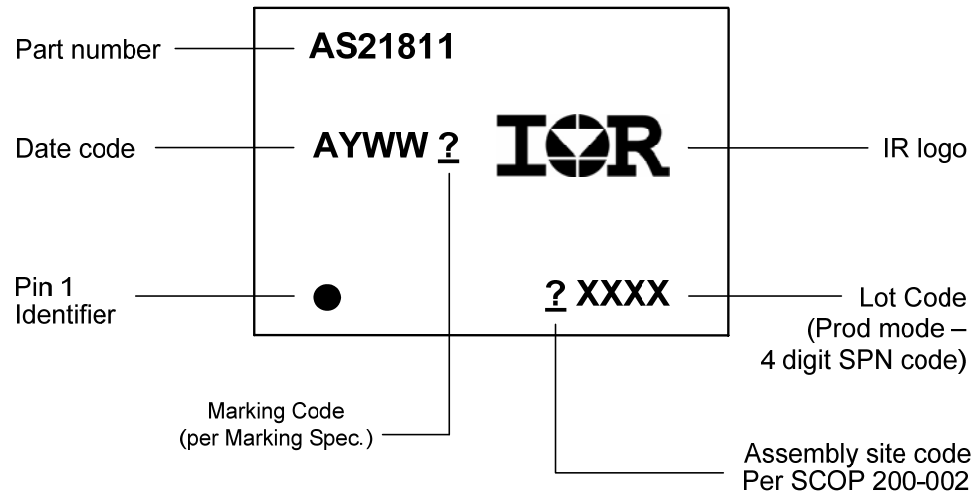
Order Information

Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	**Quantity**	
AUIRS21811	SOIC8N	Tube/Bulk	95	AUIRS21811S
		Tape and Reel	2500	AUIRS21811STR

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233 Kansas St., El Segundo, California 90245
Tel: (310) 252-7105

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Revision History

Date	Change by	Comment
8/6/08	CIC	First draft: all changes wrt AUIRS2181(4)(S) datasheet Updated all references to IC name Changed references of ton/toff to reflect requested 120ns/120ns spec Updated expected I_{QBS} and I_{QCC} specs
9/8/08	CIC	Changed product summary topology to "Half-Bridge" Changed product summary I_{O+} & I_{O-} from typ values to min values Removed reference to deadtime in the product summary Removed typical applications section Removed references to other parts in feature comparison section Changed V_{IN} from 2.7V min to 2.5V min Changed V_{OH} from 1.2V max to 1.4V max Changed V_{OL} from 0.1V max to 0.2V max Updated functional block diagrams Updated lead definitions and lead assignments, added device label for lead assignment Added typical application diagram section Added simplified block diagram section Added input/output pin equivalent diagrams Added in application info and additional details section Added in parameter temperature trend section
10/31/08	CIC	Changed VB max to 620V (align with rest of 20V clamp drivers spec)
2/24/09	CIC	Updated the qual table (showing "TBD" for ESD/LU ratings)
2/26/09	CIC	Removed IRS218114
3/10/09	CIC	Removed Simplified Bock Diagram Removed Typical Application Diagram Removed Parameter Temp Trend Section Updated page number references
3/23/09	CIC	Changed Io+/- units to A from mA
5/20/09	CIC	Added ESD and LU ratings
6/9/09	APBU	Front page: "Logic and power ground +/- 5V offset" sentence erased (only one ground exists). Page 3: "designed for minimum driver cross-conduction" sentence erased. Page 5, 6, 8: Vss related sentences erased or modified (Vss does not exist).
7/17/09	CIC	Removed min spec on Io+/- parameters Changed typ ton/toff to 135ns
9/08/09	APBU	Added Typical Applications on front page, Extended Feature comparison table, added junction temperature range in Dynamic and Static electrical characteristic tables.
9/14/09	APBU	Added tri-temp plots, added ESD passing threshold voltage, corrected $I_{O+/-}$ & $T_{on/off}$ typical value on front page to be consistent with data in table
9/15/09	APBU	Corrected list of Typical Applications on front page
9/16/09	APBU	Dyn el. Char table: Max turn on and off prop. Delay changed from 180 ns to 210 ns, removed temperature range from Statics and Dynamic Electrical Characteristic tables
9/16/09	CIC	Change the year to 2009 in header Separated Marking info and order info in two pages
9/17/09	CIC	Fixed ESD passing thresholds
10/6/09	APBU	LU rating to "tbd", added SOA page, updated marking, updated table of content, added guaranteed by design note for IO+/- parameters, removed typ. t_r/t_f,
10/08/09	APBU	Removed SOA page and updated table of content.
10/09/09	APBU	Changed Max turn on/off to 230ns to allow for tri-temp variations

1/6/2010	APBU	Removed Latch Up Rating from Qual Info page; updated ton/toff typical in comparison table for AUIRS2181(4)S to 160/200ns & for AUIRS2184(4)S to 600/230ns; modified disclaimer under Absolute Max. Rating; added Important Notice
2/24/10	APBU	Page 6: Added I_{O25+} and I_{O25-} specification and the note
05/07/10	APBU	Corrected topology to High and Low Side driver on front page.
28 July 2010	APBU	Clamp voltage changed from 25V to 20V in input output pin equivalent circuit diagram.